LY E65F

Power TOPLED® Lens

PowerTOPLED with lens, a powerful member of the TOPLED family. Thanks to their high luminous efficacy, the LEDs are ideal for rear light clusters and indicators on vehicles and for display panels for traffic control systems.

Applications

- Interior Illumination (e.g. Ambient Map)
- Signalling
- Traffic Lights

Features:

- Package: white PLCC-4 package, colorless clear resin
- Chip technology: Thinfilm
- Typ. Radiation: 60°
- Color: λ_{dom} = 590 nm (● yellow)
- Corrosion Robustness Class: 3B
- Qualifications: AEC-Q102 Qualified
- ESD: 2 kV acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 2)

Ordering Information

Type	Luminous Intensity [1] I_F = 50 mA I_v	Ordering Code
LY E65F-DAEA-35-3B5A	4500 ... 9000 mcd	Q65112A3254
LY E65F-DBFA-46-3B5A	5600 ... 14000 mcd	Q65112A3253

Maximum Ratings

Parameter	Symbol		Values
Operating Temperature	T_{op}	min. max.	-40 °C 100 °C
Storage Temperature	T_{stg}	min. max.	-40 °C 100 °C
Junction Temperature	T_j	max.	125 °C
Forward current T_S = 25 °C	I_F	max.	70 mA
Surge Current t ≤ 10 µs; D = 0.005 ; T_S = 25 °C	I_{FS}	max.	100 mA
Reverse voltage [2)] T_S = 25 °C	V_R	max.	12 V
ESD withstand voltage acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 2)	V_{ESD}		2 kV

Characteristics

I_F = 50 mA; T_S = 25 °C

Parameter	Symbol		Values
Peak Wavelength	λ_{peak}	typ.	597 nm
Dominant Wavelength [3] I_F = 50 mA	λ_{dom}	min. typ. max.	583 nm 590 nm 595 nm
Spectral Bandwidth at 50% $I_{rel,max}$	$\Delta\lambda$	typ.	18 nm
Viewing angle at 50% I_V	2φ	typ.	60 °
Forward Voltage [4] I_F = 50 mA	V_F	min. typ. max.	2.05 V 2.15 V 2.65 V
Reverse current [2] V_R = 12 V	I_R	typ. max.	0.01 µA 10 µA
Temperature Coefficient of Peak Wavelength -10°C ≤ T ≤ 100°C	$TC_{\lambda peak}$	typ.	0.12 nm / K
Real thermal resistance junction/solderpoint [5]	$R_{thJS\ real}$	typ. max.	110 K / W 130 K / W
Electrical thermal resistance junction/solderpoint [5] with efficiency η_e = 10 %	$R_{thJS\ elec.}$	typ. max.	99 K / W 117 K / W

Brightness Groups

Group	Luminous Intensity [1] I_F = 50 mA min. I_v	Luminous Intensity. [1] I_F = 50 mA max. I_v	Luminous Flux [6] I_F = 50 mA typ. Φ_V
DA	4500 mcd	5600 mcd	5610 mlm
DB	5600 mcd	7100 mcd	7050 mlm
EA	7100 mcd	9000 mcd	8940 mlm
EB	9000 mcd	11200 mcd	11210 mlm
FA	11200 mcd	14000 mcd	13990 mlm

Forward Voltage Groups

Group	Forward Voltage [4] I_F = 50 mA min. V_F	Forward Voltage [4] I_F = 50 mA max. V_F
3B	2.05 V	2.20 V
4A	2.20 V	2.35 V
4B	2.35 V	2.50 V
5A	2.50 V	2.65 V

Wavelength Groups

Group	Dominant Wavelength [3] I_F = 50 mA min. λ_{dom}	Dominant Wavelength [3] I_F = 50 mA max. λ_{dom}
3	583 nm	586 nm
4	586 nm	589 nm
5	589 nm	592 nm
6	592 nm	595 nm

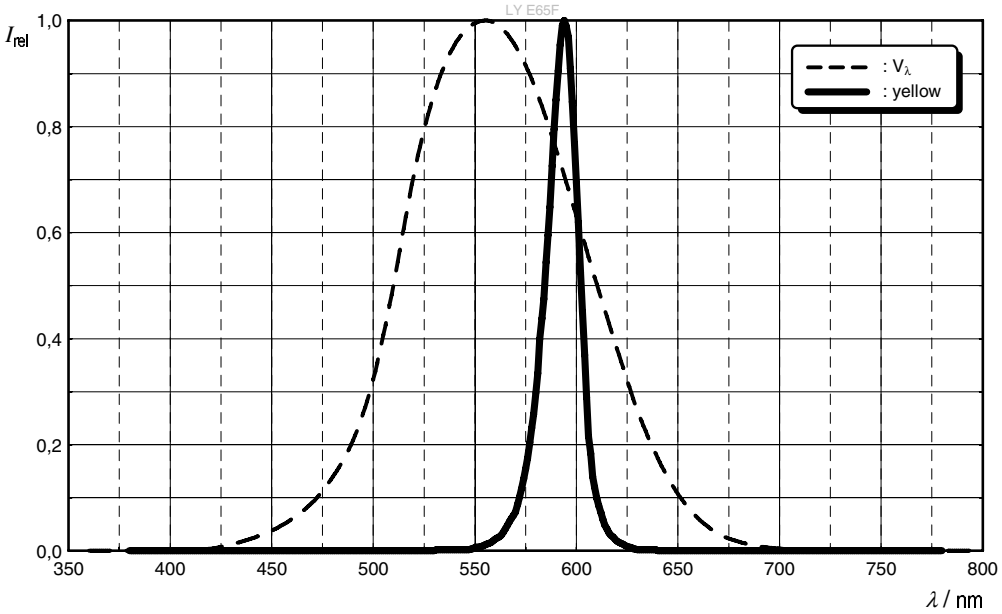
Group Name on Label

Example: DA-3-3B

Brightness	Wavelength	Forward Voltage
DA	3	3B

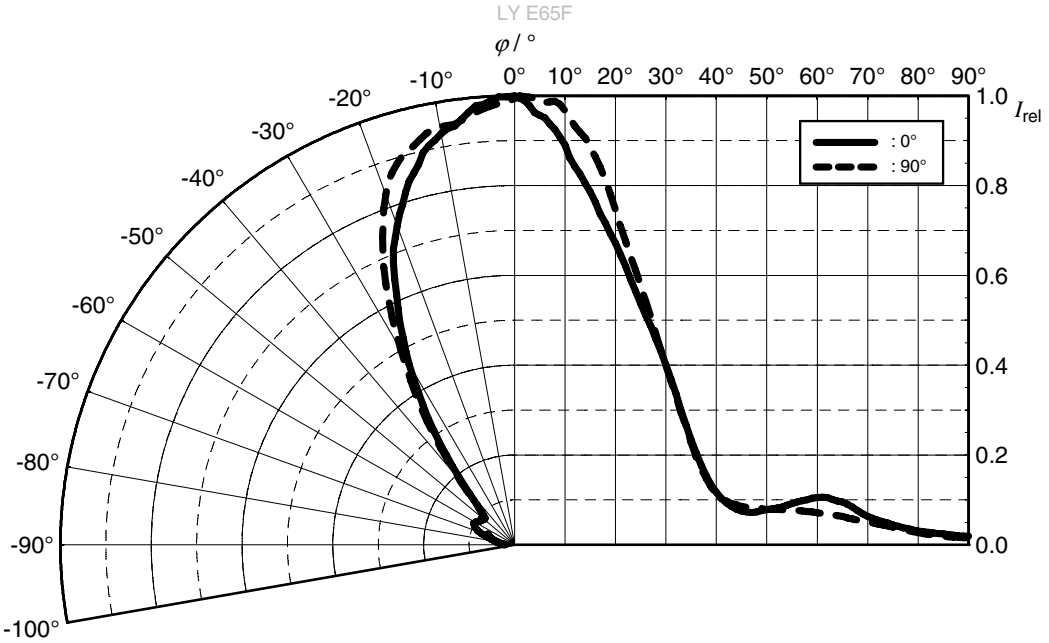
Relative Spectral Emission [6)]

$I_{rel} = f(\lambda)$; $I_F = 50$ mA; $T_S = 25$ °C



Radiation Characteristics [6)]

$I_{rel} = f(\phi)$; $T_S = 25$ °C



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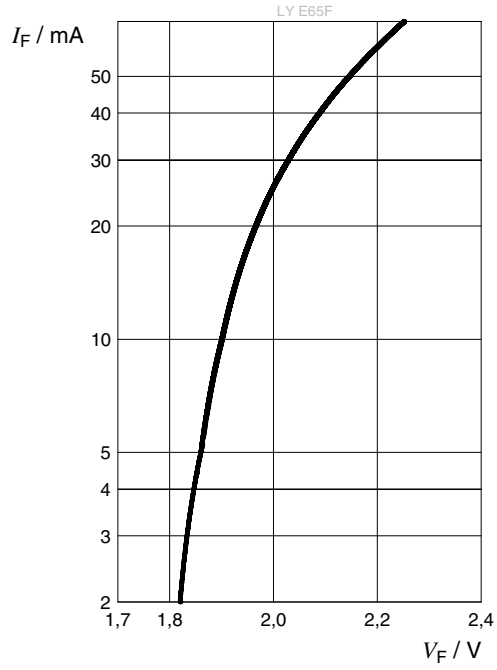
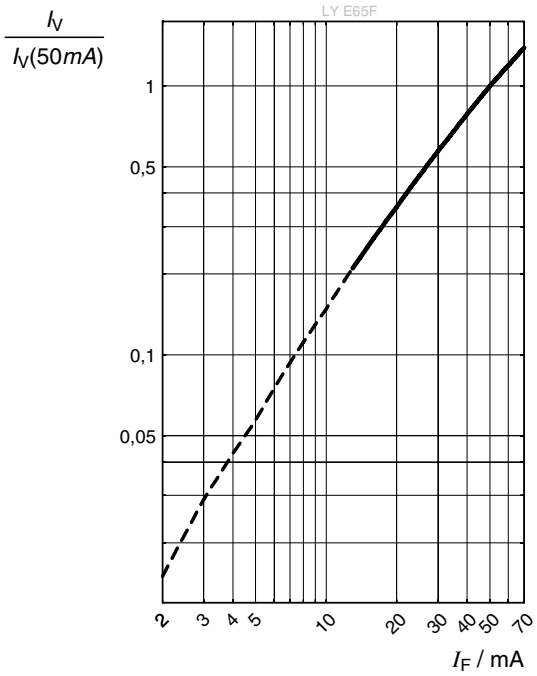
Forward current 6), 7)

$I_F = f(V_F)$; T_S = 25 °C



Relative Luminous Intensity 6), 7)

$I_v/I_v(50\ mA) = f(I_F)$; T_S = 25 °C



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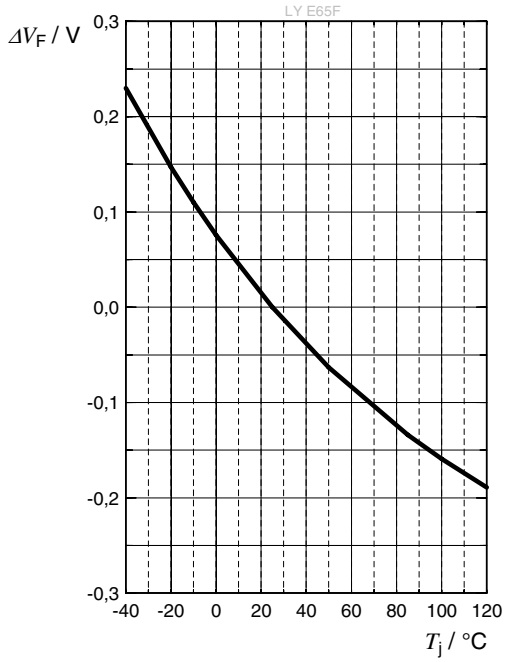
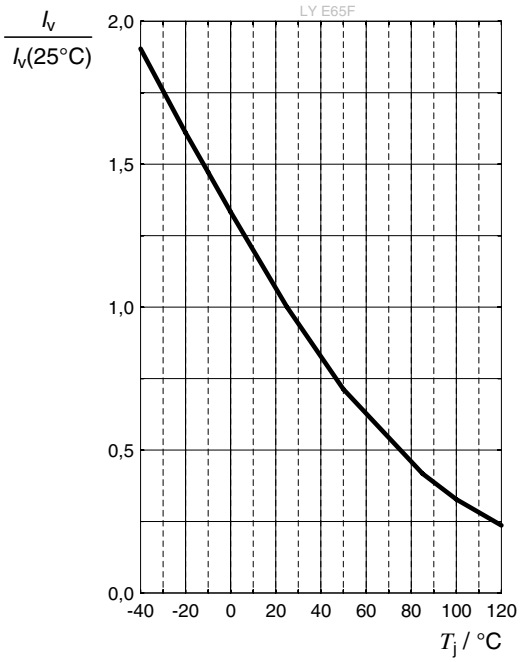
Forward Voltage [6)]

$\Delta V_F = V_F - V_F(25\ °C) = f(T_j);\ I_F = 50\ mA$



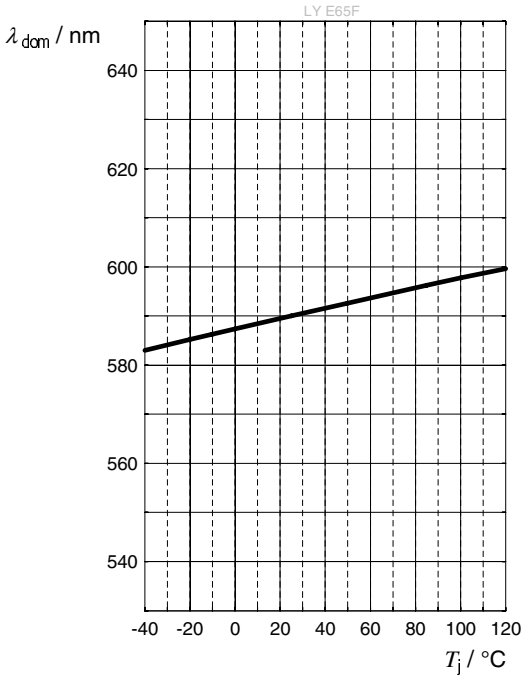
Relative Luminous Intensity [6)]

$I_v/I_v(25\ °C) = f(T_j);\ I_F = 50\ mA$



Dominant Wavelength [6)]

$\lambda_{dom} = f(T_j);\ I_F = 50\ mA$



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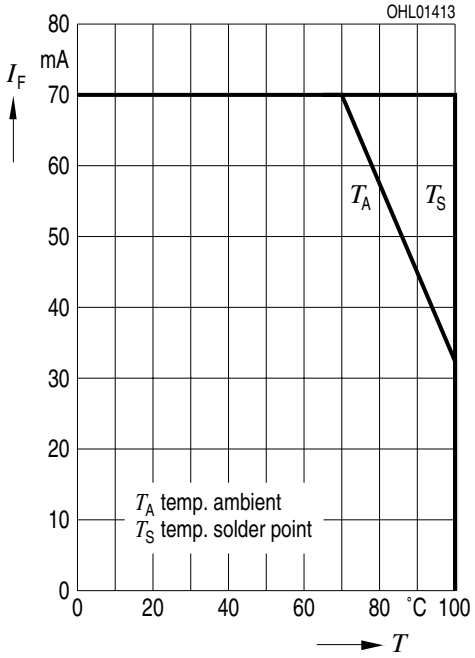
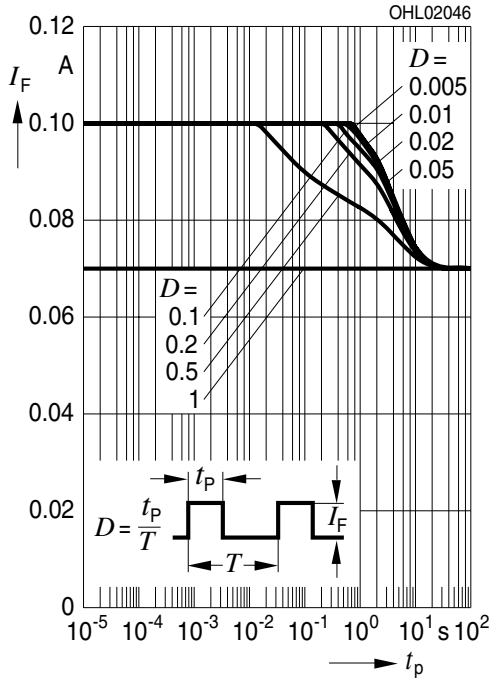
Max. Permissible Forward Current

$I_F = f(T)$



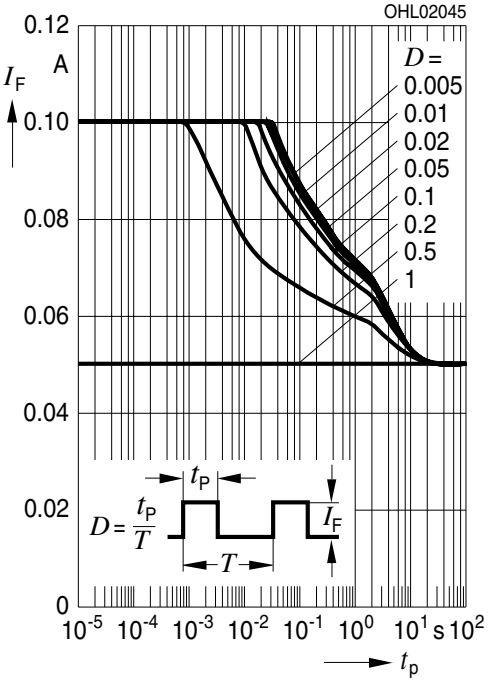
Permissible Pulse Handling Capability

$I_F = f(t_p)$; D: Duty cycle; T_A = 25 °C



Permissible Pulse Handling Capability

$I_F = f(t_p)$; D: Duty cycle; T_A = 85 °C



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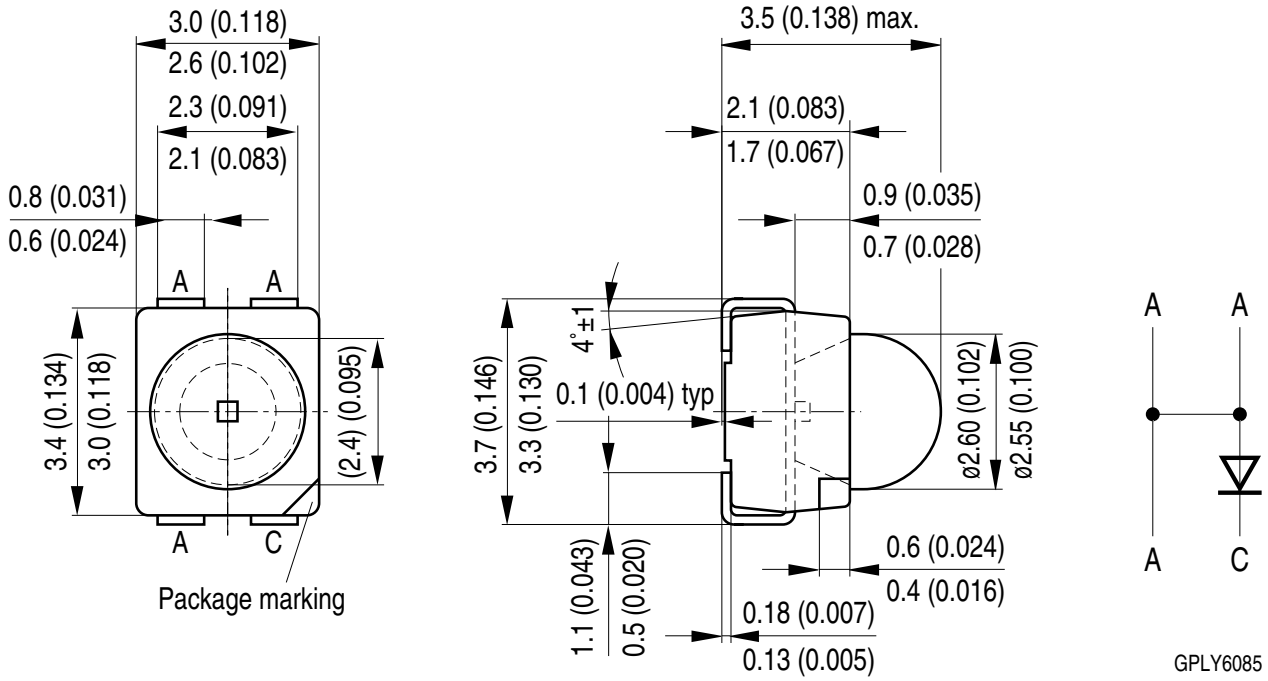
Dimensional Drawing [8)]



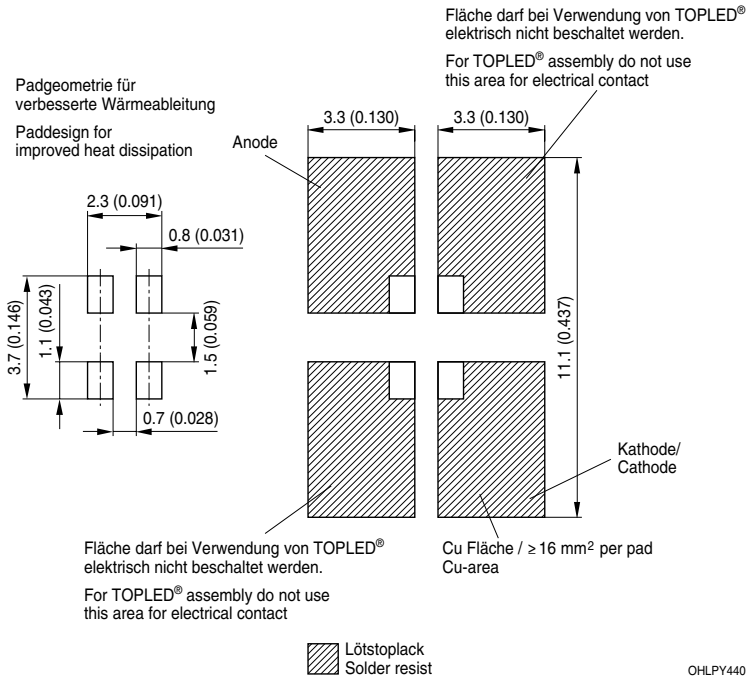
Further Information:

Approximate Weight: 38.0 mg

Package marking: Cathode

Corrosion test: Class: 3B
Test condition: 40°C / 90 % RH / 15 ppm H_2S / 14 days (stricter than IEC 60068-2-43)

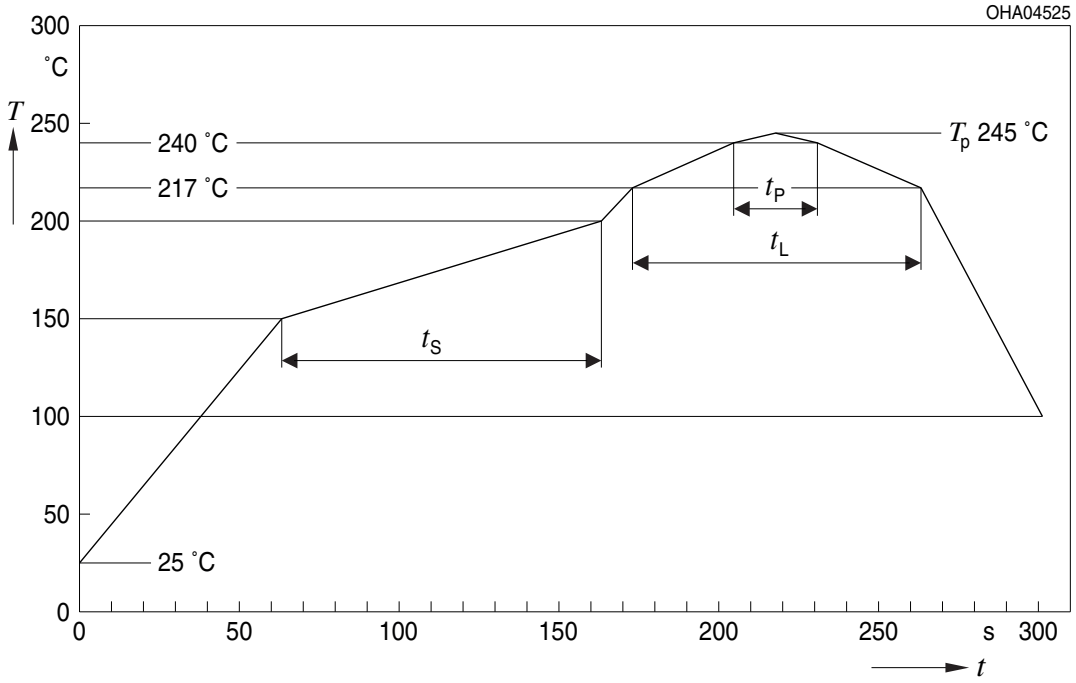
Recommended Solder Pad [8)]



For superior solder joint connectivity results we recommend soldering under standard nitrogen atmosphere. Package not suitable for ultra sonic cleaning.

Reflow Soldering Profile

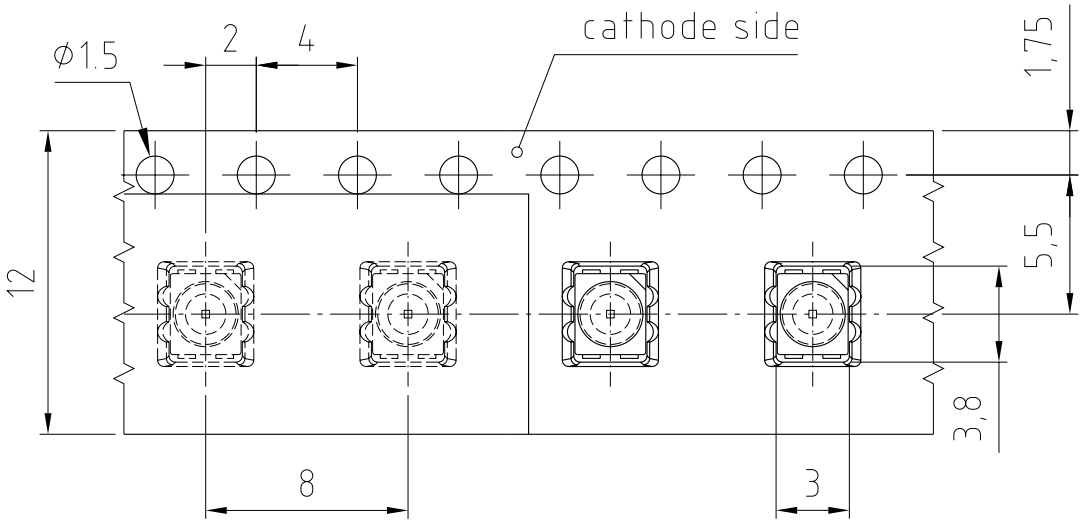
Product complies to MSL Level 2 acc. to JEDEC J-STD-020E



Profile Feature	Symbol	Pb-Free (SnAgCu) Assembly			Unit
		Minimum	Recommendation	Maximum	
Ramp-up rate to preheat*) 25 °C to 150 °C			2	3	K/s
Time t_S T_{Smin} to T_{Smax}	t_S	60	100	120	s
Ramp-up rate to peak*) T_{Smax} to T_P			2	3	K/s
Liquidus temperature	T_L		217		°C
Time above liquidus temperature	t_L		80	100	s
Peak temperature	T_P		245	250	°C
Time within 5 °C of the specified peak temperature T_P - 5 K	t_P	10	20	30	s
Ramp-down rate* T_P to 100 °C			3	4	K/s
Time 25 °C to T_P				480	s

All temperatures refer to the center of the package, measured on the top of the component
* slope calculation DT/Dt: Dt max. 5 s; fulfillment for the whole T-range

Taping [8)]



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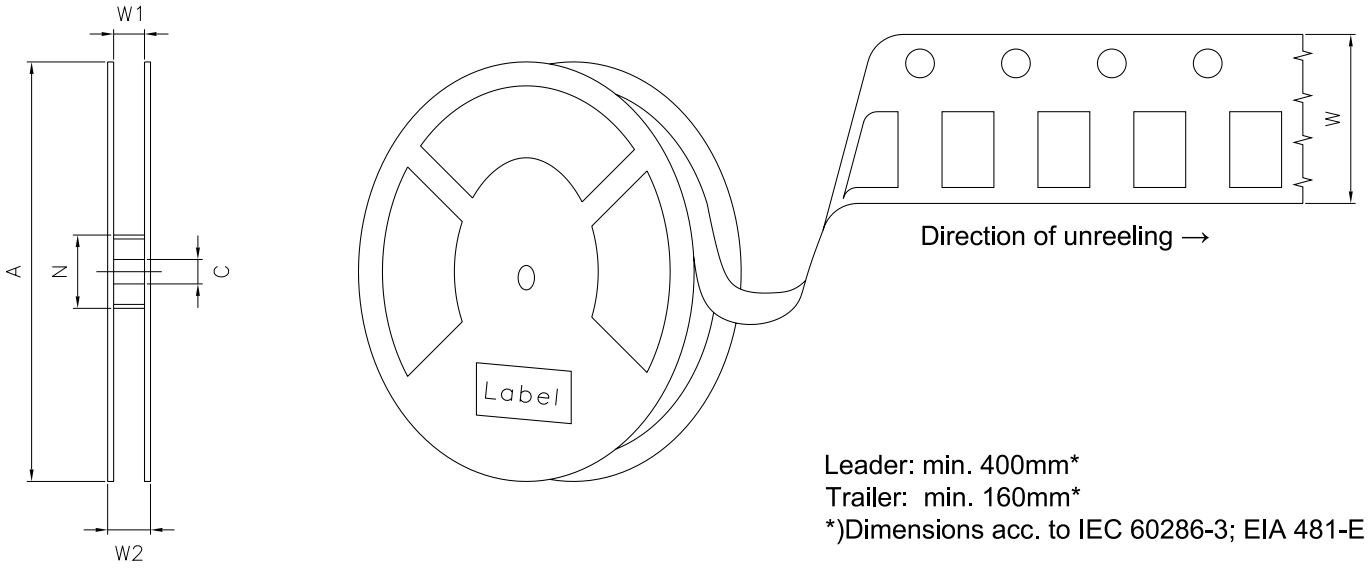
Tape and Reel [9)]

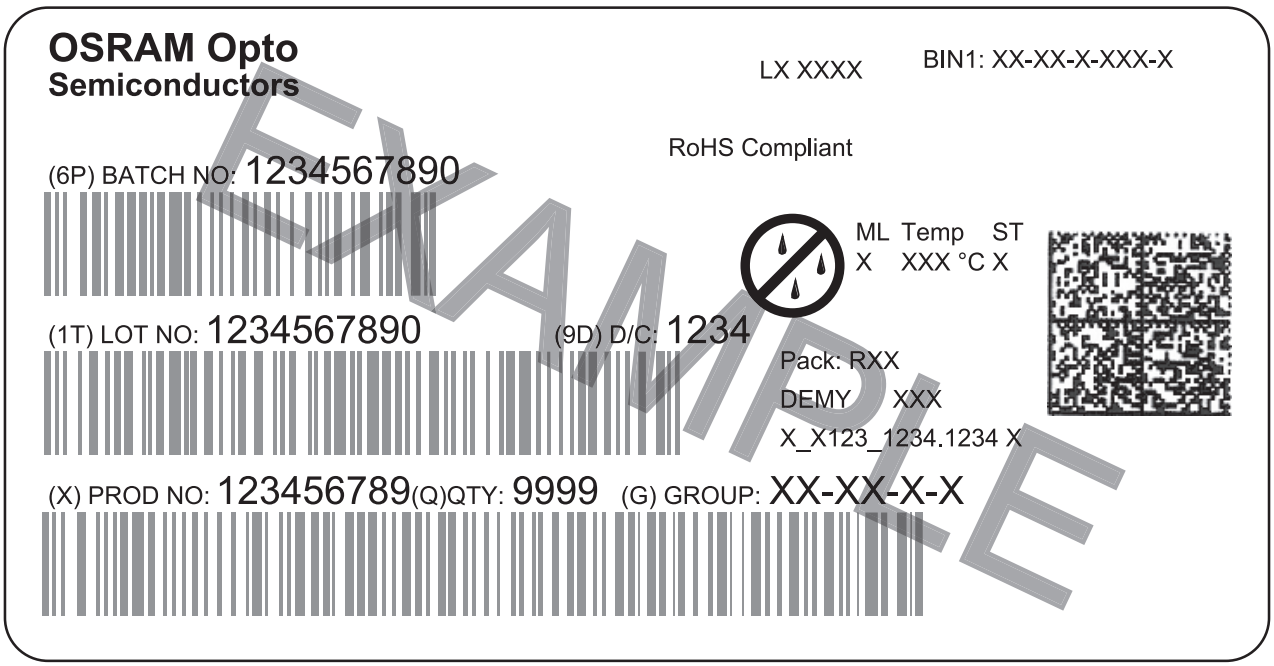


Leader: min. 400mm*
Trailer: min. 160mm*
*)Dimensions acc. to IEC 60286-3; EIA 481-E

Reel Dimensions

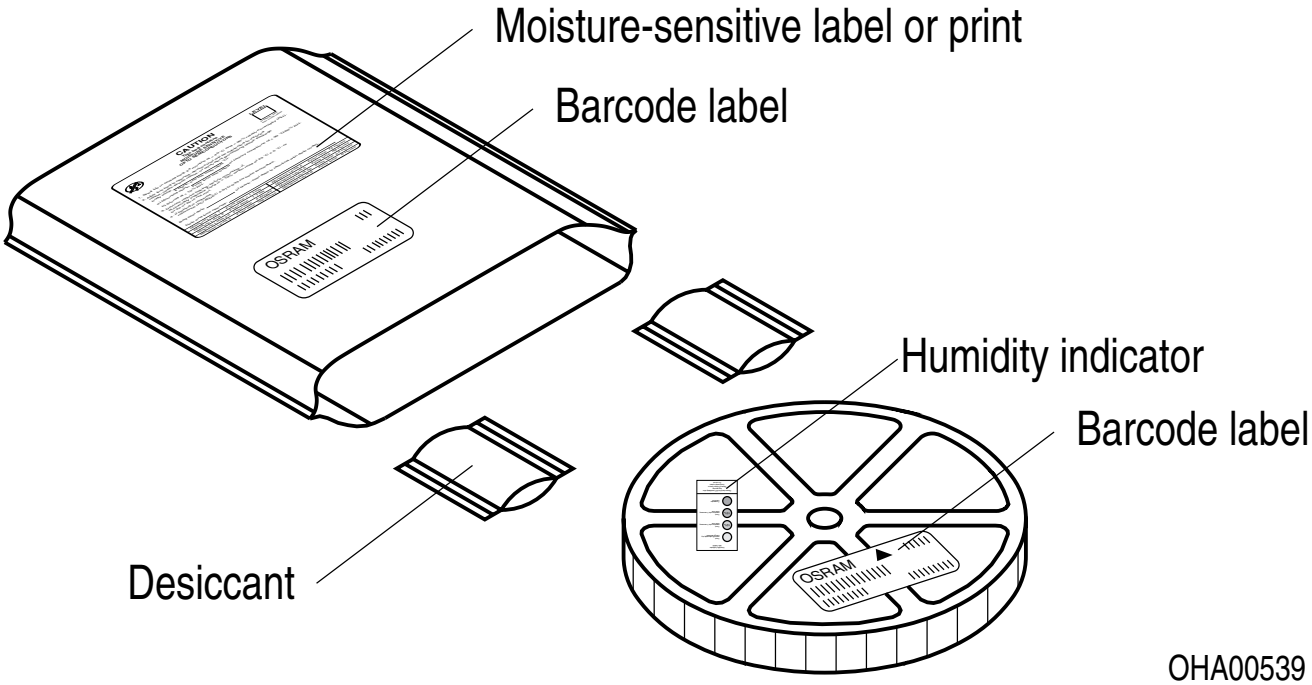
A	W	N_{min}	W_1	$W_{2\,max}$	Pieces per PU
330 mm	12 + 0.3 / - 0.1 mm	60 mm	12.4 + 2 mm	18.4 mm	2000

Barcode-Product-Label (BPL)



OHA04563

Dry Packing Process and Materials [8)]



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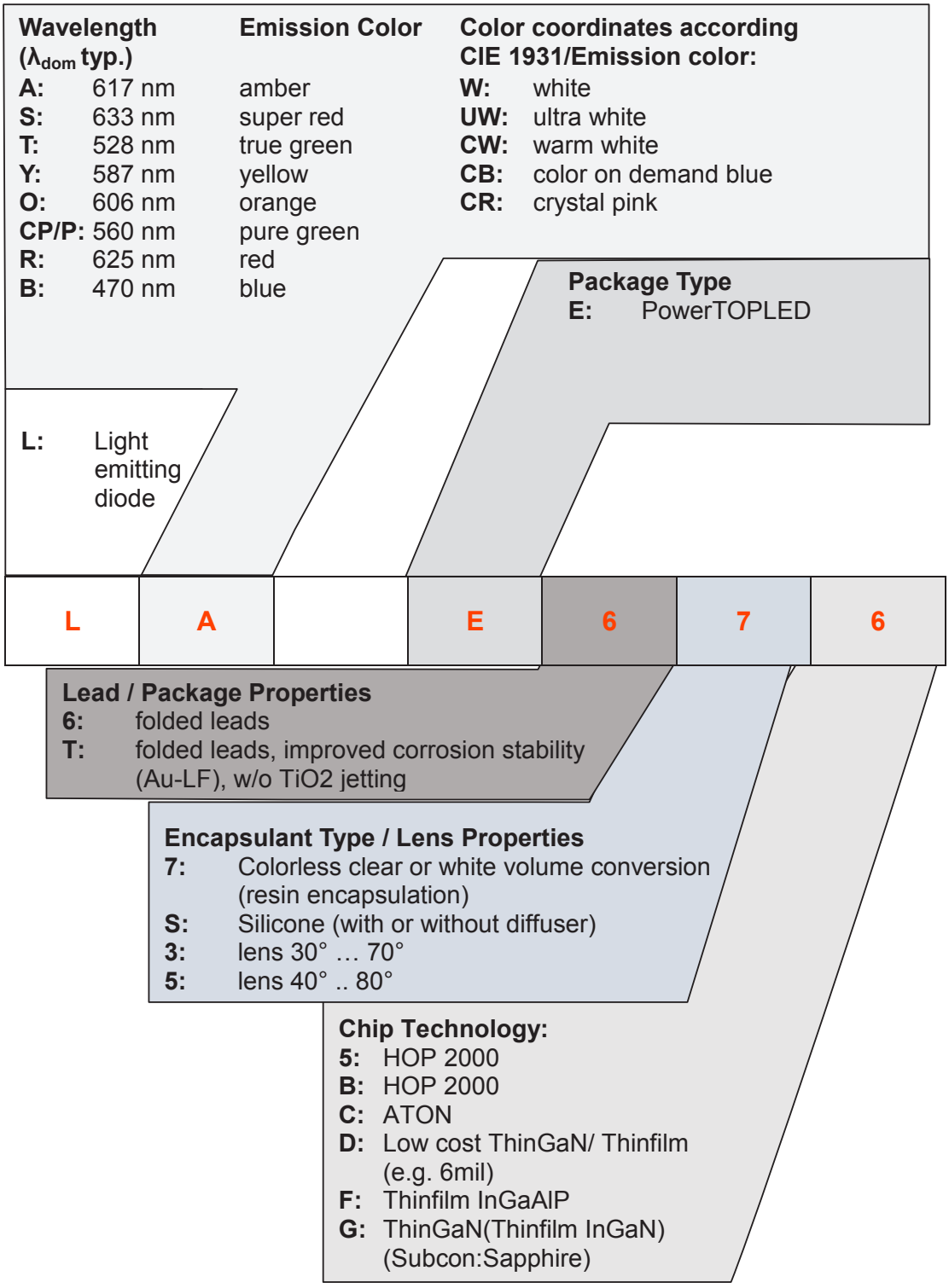
Moisture-sensitive product is packed in a dry bag containing desiccant and a humidity card according JEDEC-STD-033.

Type Designation System



Notes

The evaluation of eye safety occurs according to the standard IEC 62471:2006 (photo biological safety of lamps and lamp systems). Within the risk grouping system of this IEC standard, the device specified in this data sheet falls into the class **exempt group (exposure time 10000 s)**. Under real circumstances (for exposure time, conditions of the eye pupils, observation distance), it is assumed that no endangerment to the eye exists from these devices. As a matter of principle, however, it should be mentioned that intense light sources have a high secondary exposure potential due to their blinding effect. When looking at bright light sources (e.g. headlights), temporary reduction in visual acuity and afterimages can occur, leading to irritation, annoyance, visual impairment, and even accidents, depending on the situation.

Subcomponents of this device contain, in addition to other substances, metal filled materials including silver. Metal filled materials can be affected by environments that contain traces of aggressive substances. Therefore, we recommend that customers minimize device exposure to aggressive substances during storage, production, and use. Devices that showed visible discoloration when tested using the described tests above did show no performance deviations within failure limits during the stated test duration. Respective failure limits are described in the IEC60810.

For further application related information please visit www.osram-os.com/appnotes

Disclaimer

Attention please!
The information describes the type of component and shall not be considered as assured characteristics.
Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances.
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Packing
Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office. By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

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OSRAM OS components are not developed, constructed or tested for the application as safety relevant component or for the application in medical devices.
OSRAM OS products are not qualified at module and system level for such application.

In case buyer – or customer supplied by buyer – considers using OSRAM OS components in product safety devices/applications or medical devices/applications, buyer and/or customer has to inform the local sales partner of OSRAM OS immediately and OSRAM OS and buyer and /or customer will analyze and coordinate the customer-specific request between OSRAM OS and buyer and/or customer.

Glossary

1) **Brightness:** Brightness values are measured during a current pulse of typically 25 ms, with an internal reproducibility of ±8 % and an expanded uncertainty of ±11 % (acc. to GUM with a coverage factor of k = 3).

2) **Reverse Operation:** Reverse Operation of 10 hours is permissible in total. Continuous reverse operation is not allowed.

3) **Wavelength:** The wavelength is measured at a current pulse of typically 25 ms, with an internal reproducibility of ±0.5 nm and an expanded uncertainty of ±1 nm (acc. to GUM with a coverage factor of k = 3).

4) **Forward Voltage:** The forward voltage is measured during a current pulse of typically 8 ms, with an internal reproducibility of ±0.05 V and an expanded uncertainty of ±0.1 V (acc. to GUM with a coverage factor of k = 3).

5) **Thermal Resistance:** Rth max is based on statistic values (6σ).

6) **Typical Values:** Due to the special conditions of the manufacturing processes of semiconductor devices, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.

7) **Characteristic curve:** In the range where the line of the graph is broken, you must expect higher differences between single devices within one packing unit.

8) **Tolerance of Measure:** Unless otherwise noted in drawing, tolerances are specified with ±0.1 and dimensions are specified in mm.

9) **Tape and Reel:** All dimensions and tolerances are specified acc. IEC 60286-3 and specified in mm.

Revision History

Version	Date	Change
1.6	2020-01-15	Features Electro - Optical Characteristics (Diagrams) Brightness Groups Dimensions of Transportation Box Disclaimer

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按照中国的相关法规和标准，不含有毒有害物质或元素。

LifeElectronics
Живое партнерство

ООО «ЛайфЭлектроникс» **“LifeElectronics” LLC**

ИНН 7805602321 КПП 780501001 Р/С 40702810122510004610 ФАКБ "АБСОЛЮТ БАНК" (ЗАО) в г.Санкт-Петербурге К/С 30101810900000000703 БИК 044030703

Компания «Life Electronics» занимается поставками электронных компонентов импортного и отечественного производства от производителей и со складов крупных дистрибьюторов Европы, Америки и Азии.

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- *Подбор аналогов.*
- *Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.*

- *Приемлемые сроки поставки, возможна ускоренная поставка.*
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- *Тестирование поставляемой продукции.*
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Тел: +7 (812) 336 43 04 (многоканальный)
Email: org@lifeelectronics.ru

www.lifeelectronics.ru